# 4V Drive Pch MOSFET RSE002P03

### ●Structure

Silicon P-channel MOSFET

# ● Features

- 1) Low On-resistance.
- 2) Small package (EMT3).
- 3) 4V drive.

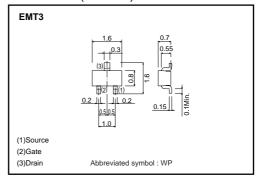
# Applications

Switching

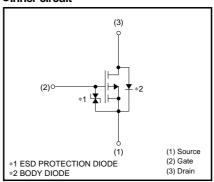
## Package specifications

	Package	Taping	
Type	Code	TL	
	Basic ordering unit (pieces)	3000	
RSE002P03	0		

# ● **Dimensions** (Unit: mm)



### •Inner circuit



# ● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Drain-source voltage		$V_{DSS}$	-30	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Dunin august	Continuous	ID	±0.2	Α	
Drain current	Pulsed	I <sub>DP</sub> *1	±0.4	Α	
Total power dissipation		P <sub>D</sub> *2	0.15	W	
Channel temperature		Tch	150	°C	
Range of storage temperature		Tstg	-55 to +150	°C	

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1%

### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	833	°C/W

 $<sup>\</sup>ast$  Each terminal mounted on a recommended land

<sup>\*2</sup> Each terminal mounted on a recommended land

# ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	_	±10	μΑ	Vgs= ±20V, Vps=0V
Drain-source breakdown voltage	V(BR) DSS	-30	_	_	V	ID= -1mA, VGS=0V
Zero gate voltage drain current	IDSS	_	_	-1	μΑ	Vps= -30V, Vgs=0V
Gate threshold voltage	V <sub>GS (th)</sub>	-1.0	_	-2.5	V	V <sub>DS</sub> = -10V, I <sub>D</sub> = -1mA
Static drain-source on-state resistance	R <sub>DS</sub> (on)*	_	0.9	1.4	Ω	I <sub>D</sub> = -0.2A, V <sub>G</sub> S= -10V
		_	1.4	2.1	Ω	I <sub>D</sub> = -0.15A, V <sub>G</sub> s= -4.5V
		_	1.6	2.4	Ω	I <sub>D</sub> = -0.15A, V <sub>G</sub> s= -4.0V
Forward transfer admittance	Y <sub>fs</sub> *	0.2	_	_	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.15A
Input capacitance	Ciss	_	30	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	_	4	_	pF	V <sub>GS</sub> = 0V
Reverse transfer capacitance	Crss	_	5	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	_	8	_	ns	Vpp≒ –15V
Rise time	tr *	_	5	_	ns	ID= -0.15A
Turn-off delay time	t <sub>d (off)</sub> *	_	30	_	ns	V <sub>GS</sub> = -10V R <sub>L</sub> = 100Ω
Fall time	t <sub>f</sub> *	-	40	_	ns	R <sub>G</sub> = 10Ω

\*Pulsed

# ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	_	_	-1.2	V	I <sub>S</sub> = -0.1A, V <sub>GS</sub> =0V

#### Electrical characteristics curves

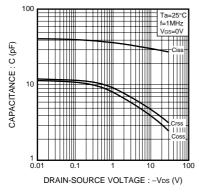


Fig.1 Typical Capacitance vs. Drain-Source Voltage

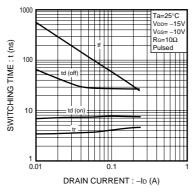


Fig.2 Switching Characteristics

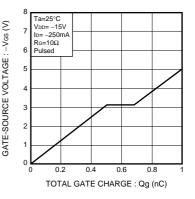


Fig.3 Dynamic Input Characteristics

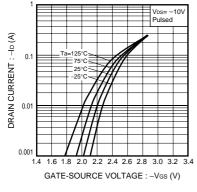


Fig.4 Typical Transfer Characteristics

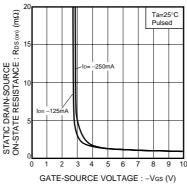


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

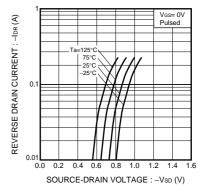


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

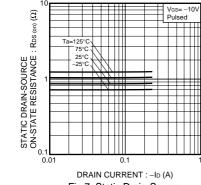
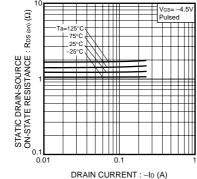
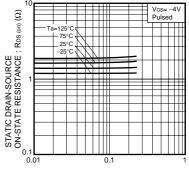


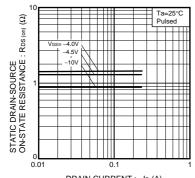
Fig.7 Static Drain-Source
On-State Resistance vs.
Drain current (I)



DRAIN CURRENT : -ID (A)
Fig.8 Static Drain-Source
On-State Resistance vs.
Drain current ( II )



DRAIN CURRENT : -ID (A)
Fig.9 Static Drain-Source
On-State Resistance vs.
Drain current ( III )



DRAIN CURRENT: -Io (A)
Fig.10 Static Drain-Source
On-State Resistance vs.
Drain current ( IV )

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